

## Insulated Gate Bipolar Transistor (Ultrafast IGBT), 100 A



SOT-227

### FEATURES

- Trench IGBT high speed
- Square RBSOA
- HEXFRED® low  $Q_{rr}$ , low switching energy
- Positive  $V_{CE(on)}$  temperature coefficient
- Fully isolated package
- Very low internal inductance ( $\leq 5$  nH typical)
- Industry standard outline
- UL approved file E78996 
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


RoHS  
COMPLIANT

### PRIMARY CHARACTERISTICS

|                                      |                             |
|--------------------------------------|-----------------------------|
| $V_{CES}$                            | 1200 V                      |
| $I_C$ DC                             | 100 A at 108 °C             |
| $V_{CE(on)}$ typical at 100 A, 25 °C | 1.93 V                      |
| Speed                                | 8 kHz to 30 kHz             |
| Package                              | SOT-227                     |
| Circuit configuration                | Single switch with AP diode |

### BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting on heatsink
- Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

### ABSOLUTE MAXIMUM RATINGS

| PARAMETER                        | SYMBOL     | TEST CONDITIONS                                            | MAX.     | UNITS |
|----------------------------------|------------|------------------------------------------------------------|----------|-------|
| Collector to emitter voltage     | $V_{CES}$  |                                                            | 1200     | V     |
| Continuous collector current     | $I_C$      | $T_C = 25\text{ °C}$                                       | 187      | A     |
|                                  |            | $T_C = 90\text{ °C}$                                       | 123      |       |
| Pulsed collector current         | $I_{CM}$   |                                                            | 240      |       |
| Clamped inductive load current   | $I_{LM}$   |                                                            | 250      |       |
| Gate to emitter voltage          | $V_{GE}$   |                                                            | $\pm 20$ | V     |
| Diode continuous forward current | $I_F$      | $T_C = 25\text{ °C}$                                       | 97       | A     |
|                                  |            | $T_C = 90\text{ °C}$                                       | 61       |       |
| Single pulse forward current     | $I_{FSM}$  | 10 ms sine or 6 ms rectangular pulse, $T_J = 25\text{ °C}$ | 350      |       |
| Power dissipation, IGBT          | $P_D$      | $T_C = 25\text{ °C}$                                       | 890      | W     |
|                                  |            | $T_C = 90\text{ °C}$                                       | 500      |       |
| Power dissipation, diode         | $P_D$      | $T_C = 25\text{ °C}$                                       | 429      |       |
|                                  |            | $T_C = 90\text{ °C}$                                       | 194      |       |
| Isolation voltage                | $V_{ISOL}$ | Any terminal to case, $t = 1\text{ min}$                   | 2500     | V     |

**ELECTRICAL SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                                    | SYMBOL                  | TEST CONDITIONS                                                                                             | MIN. | TYP. | MAX.      | UNITS                  |
|----------------------------------------------|-------------------------|-------------------------------------------------------------------------------------------------------------|------|------|-----------|------------------------|
| Collector to emitter breakdown voltage       | $V_{BR(CEs)}$           | $V_{GE} = 0\text{ V}$ , $I_C = 3.8\text{ mA}$                                                               | 1200 | -    | -         | V                      |
| Collector to emitter voltage                 | $V_{CE(on)}$            | $V_{GE} = 15\text{ V}$ , $I_C = 100\text{ A}$                                                               | -    | 1.93 | 2.55      |                        |
|                                              |                         | $V_{GE} = 15\text{ V}$ , $I_C = 100\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$                         | -    | 2.26 | -         |                        |
|                                              |                         | $V_{GE} = 15\text{ V}$ , $I_C = 100\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                         | -    | 2.35 | -         |                        |
| Gate threshold voltage                       | $V_{GE(th)}$            | $V_{CE} = V_{GE}$ , $I_C = 3.8\text{ mA}$                                                                   | 4.5  | 5.8  | 7.0       |                        |
|                                              |                         | $V_{CE} = V_{GE}$ , $I_C = 3.8\text{ mA}$ , $T_J = 125\text{ }^{\circ}\text{C}$                             | -    | 4.6  | -         |                        |
| Temperature coefficient of threshold voltage | $V_{GE(th)}/\Delta T_J$ | $V_{CE} = V_{GE}$ , $I_C = 3.8\text{ mA}$ ( $25\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$ ) | -    | -12  | -         | mV/ $^{\circ}\text{C}$ |
| Collector to emitter leakage current         | $I_{CES}$               | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$                                                            | -    | 1.0  | 100       | $\mu\text{A}$          |
|                                              |                         | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                      | -    | 0.9  | -         | mA                     |
|                                              |                         | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                      | -    | 3.4  | -         |                        |
| Forward voltage drop, diode                  | $V_{FM}$                | $V_{GE} = 0\text{ V}$ , $I_F = 80\text{ A}$                                                                 | -    | 2.8  | 3.5       | V                      |
|                                              |                         | $V_{GE} = 0\text{ V}$ , $I_F = 80\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$                           | -    | 3.0  | -         |                        |
|                                              |                         | $V_{GE} = 0\text{ V}$ , $I_F = 80\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                           | -    | 3.0  | -         |                        |
| Gate to emitter leakage current              | $I_{GES}$               | $V_{GE} = \pm 20\text{ V}$                                                                                  | -    | -    | $\pm 220$ | nA                     |

**SWITCHING CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                    | SYMBOL       | TEST CONDITIONS                                                                                                                                                                        | MIN. | TYP. | MAX. | UNITS |
|------------------------------|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|-------|
| Total gate charge (turn-on)  | $Q_g$        | $V_{GE} = -15\text{ V}$ , $V_{GE} = +15\text{ V}$                                                                                                                                      | -    | 800  | -    | nC    |
| Input capacitance            | $C_{ies}$    | $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$                                                                                                                    | -    | 6150 | -    | pF    |
| Reverse transfer capacitance | $C_{res}$    |                                                                                                                                                                                        | -    | 345  | -    |       |
| Turn-on switching loss       | $E_{on}$     | $I_C = 75\text{ A}$ ,<br>$V_{CC} = 600\text{ V}$ ,<br>$V_{GE} = 15\text{ V}$ ,<br>$R_g = 1.0\text{ }\Omega$ ,<br>$L = 500\text{ }\mu\text{H}$ ,<br>$T_J = 25\text{ }^{\circ}\text{C}$  | -    | 2.2  | -    | mJ    |
| Turn-off switching loss      | $E_{off}$    |                                                                                                                                                                                        | -    | 3.0  | -    |       |
| Total switching loss         | $E_{tot}$    |                                                                                                                                                                                        | -    | 5.2  | -    |       |
| Turn-on delay time           | $t_{d(on)}$  |                                                                                                                                                                                        | -    | 131  | -    | ns    |
| Rise time                    | $t_r$        |                                                                                                                                                                                        | -    | 55   | -    |       |
| Turn-off delay time          | $t_{d(off)}$ | $I_C = 75\text{ A}$ ,<br>$V_{CC} = 600\text{ V}$ ,<br>$V_{GE} = 15\text{ V}$ ,<br>$R_g = 1.0\text{ }\Omega$ ,<br>$L = 500\text{ }\mu\text{H}$ ,<br>$T_J = 125\text{ }^{\circ}\text{C}$ | -    | 244  | -    |       |
| Fall time                    | $t_f$        |                                                                                                                                                                                        | -    | 118  | -    | mJ    |
| Turn-on switching loss       | $E_{on}$     |                                                                                                                                                                                        | -    | 2.9  | -    |       |
| Turn-off switching loss      | $E_{off}$    |                                                                                                                                                                                        | -    | 5.3  | -    | ns    |
| Total switching loss         | $E_{tot}$    |                                                                                                                                                                                        | -    | 8.2  | -    |       |
| Turn-on delay time           | $t_{d(on)}$  | $I_C = 100\text{ A}$ ,<br>$V_{CC} = 600\text{ V}$ ,<br>$V_{GE} = 15\text{ V}$ ,<br>$R_g = 1.0\text{ }\Omega$ ,<br>$L = 500\text{ }\mu\text{H}$ ,<br>$T_J = 25\text{ }^{\circ}\text{C}$ | -    | 147  | -    |       |
| Rise time                    | $t_r$        |                                                                                                                                                                                        | -    | 61   | -    | mJ    |
| Turn-off delay time          | $t_{d(off)}$ |                                                                                                                                                                                        | -    | 358  | -    |       |
| Fall time                    | $t_f$        |                                                                                                                                                                                        | -    | 132  | -    | ns    |
| Turn-on switching loss       | $E_{on}$     |                                                                                                                                                                                        | -    | 3.0  | -    |       |
| Turn-off switching loss      | $E_{off}$    | $I_C = 100\text{ A}$ ,<br>$V_{CC} = 600\text{ V}$ ,<br>$V_{GE} = 15\text{ V}$ ,<br>$R_g = 1.0\text{ }\Omega$ ,<br>$L = 500\text{ }\mu\text{H}$ ,<br>$T_J = 25\text{ }^{\circ}\text{C}$ | -    | 4.0  | -    | mJ    |
| Total switching loss         | $E_{tot}$    |                                                                                                                                                                                        | -    | 7.0  | -    |       |
| Turn-on delay time           | $t_{d(on)}$  |                                                                                                                                                                                        | -    | 134  | -    |       |
| Rise time                    | $t_r$        |                                                                                                                                                                                        | -    | 66   | -    | ns    |
| Turn-off delay time          | $t_{d(off)}$ |                                                                                                                                                                                        | -    | 242  | -    |       |
| Fall time                    | $t_f$        |                                                                                                                                                                                        | -    | 108  | -    |       |

**SWITCHING CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                         | SYMBOL              | TEST CONDITIONS                                                                                                                                     |                                                                                 | MIN.                                                                                                                                                                       | TYP. | MAX.       | UNITS |
|-----------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------|-------|
| Turn-on switching loss            | E <sub>on</sub>     | I <sub>C</sub> = 100 A,<br>V <sub>CC</sub> = 600 V,<br>V <sub>GE</sub> = 15 V,<br>R <sub>g</sub> = 1.0 Ω,<br>L = 500 μH,<br>T <sub>J</sub> = 125 °C | Energy losses<br>include tail and<br>diode recovery<br>Diode used<br>HFA16PB120 | -                                                                                                                                                                          | 3.9  | -          | mJ    |
| Turn-off switching loss           | E <sub>off</sub>    |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 7.1  | -          |       |
| Total switching loss              | E <sub>tot</sub>    |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 11.0 | -          |       |
| Turn-on delay time                | t <sub>d(on)</sub>  |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 154  | -          | ns    |
| Rise time                         | t <sub>r</sub>      |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 72   | -          |       |
| Turn-off delay time               | t <sub>d(off)</sub> |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 346  | -          |       |
| Fall time                         | t <sub>f</sub>      |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 120  | -          |       |
| Reverse bias safe operating area  | RBSOA               |                                                                                                                                                     |                                                                                 | T <sub>J</sub> = 150 °C, I <sub>C</sub> = 250 A, R <sub>g</sub> = 1.0 Ω,<br>V <sub>GE</sub> = 15 V to 0 V, V <sub>CC</sub> = 800 V,<br>V <sub>P</sub> = 1200 V, L = 500 μH |      | Fullsquare |       |
| Short circuit safe operating area | SCSOA               | V <sub>GE</sub> = 15 V, V <sub>CC</sub> = 800 V,<br>V <sub>CE</sub> max. = 1200 V, T <sub>VJ</sub> = 150 °C                                         |                                                                                 | -                                                                                                                                                                          | -    | 10         | μs    |
| Diode reverse recovery time       | t <sub>rr</sub>     | I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 400 V                                                                       |                                                                                 | -                                                                                                                                                                          | 183  | -          | ns    |
| Diode peak reverse current        | I <sub>rr</sub>     |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 12   | -          | A     |
| Diode recovery charge             | Q <sub>rr</sub>     |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 1093 | -          | nC    |
| Diode reverse recovery time       | t <sub>rr</sub>     | I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 400 V,<br>T <sub>J</sub> = 125 °C                                           |                                                                                 | -                                                                                                                                                                          | 278  | -          | ns    |
| Diode peak reverse current        | I <sub>rr</sub>     |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 18.2 | -          | A     |
| Diode recovery charge             | Q <sub>rr</sub>     |                                                                                                                                                     |                                                                                 | -                                                                                                                                                                          | 2541 | -          | nC    |

**THERMAL AND MECHANICAL SPECIFICATIONS**

| PARAMETER                              | SYMBOL         | TEST CONDITIONS       | MIN. | TYP. | MAX.       | UNITS                       |
|----------------------------------------|----------------|-----------------------|------|------|------------|-----------------------------|
| Junction and storage temperature range | $T_J, T_{Stg}$ |                       | -40  | -    | 150        | $^{\circ}\text{C}$          |
| Junction to case                       | IGBT           |                       | -    | -    | 0.14       | $^{\circ}\text{C}/\text{W}$ |
|                                        | Diode          |                       | -    | -    | 0.31       |                             |
| Case to heatsink                       | $R_{thCS}$     | Flat, greased surface | -    | 0.1  | -          |                             |
| Weight                                 |                |                       | -    | 30   | -          | g                           |
| Mounting torque                        |                | Torque to terminal    | -    | -    | 1.1 (9.7)  | Nm (lbf. in)                |
|                                        |                | Torque to heatsink    | -    | -    | 1.3 (11.5) | Nm (lbf. in)                |
| Case style                             | SOT-227        |                       |      |      |            |                             |

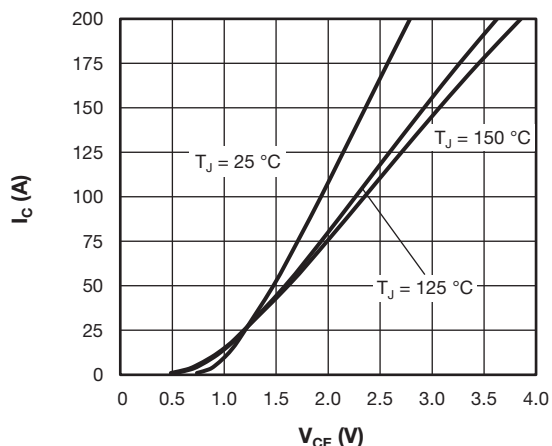
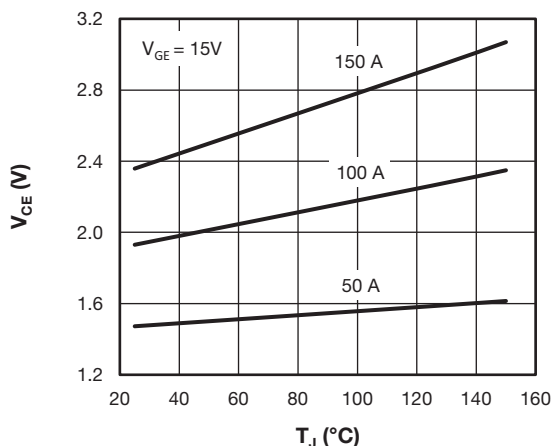

Fig. 1 - Typical IGBT Output Characteristics,  $V_{GE} = 15\text{ V}$ 


Fig. 4 - Collector to Emitter Voltage vs. Junction Temperature

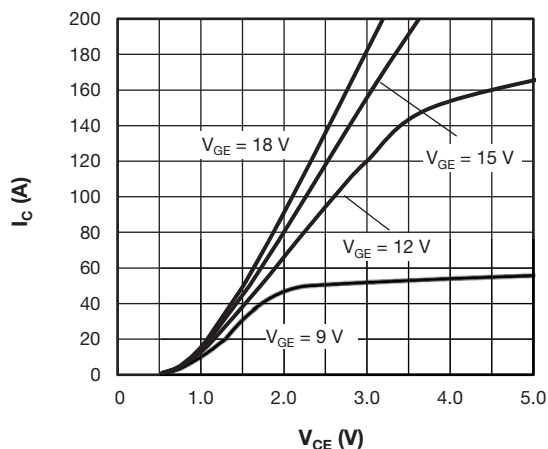
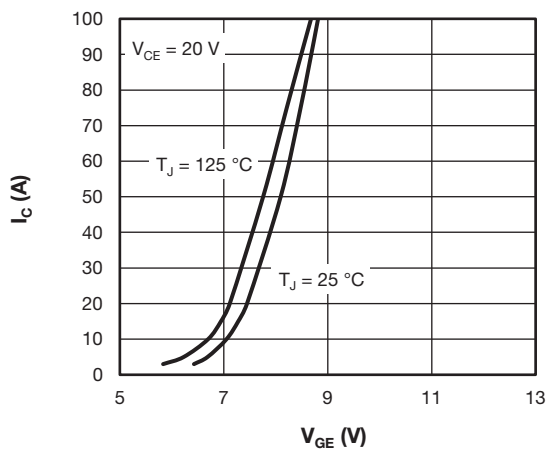

Fig. 2 - Typical IGBT Output Characteristics,  $T_J = 125\text{ °C}$ 


Fig. 5 - Typical IGBT Transfer Characteristics

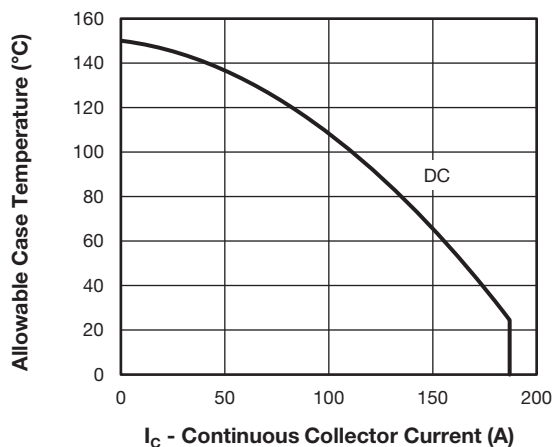


Fig. 3 - Maximum IGBT Continuous Collector Current vs. Case Temperature

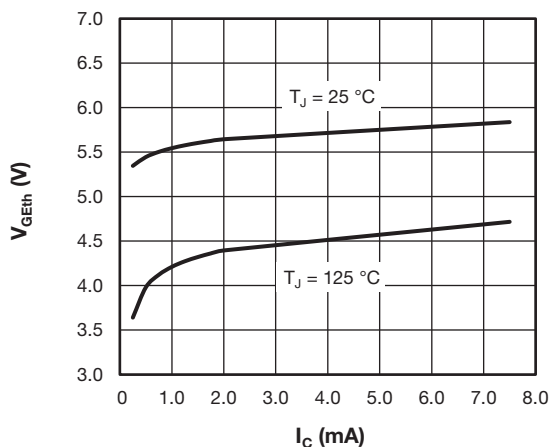


Fig. 6 - Typical IGBT Gate Threshold Voltage

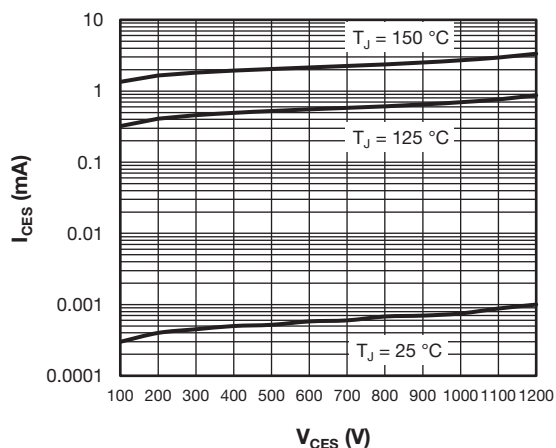


Fig. 7 - Typical IGBT Zero Gate Voltage Collector Current

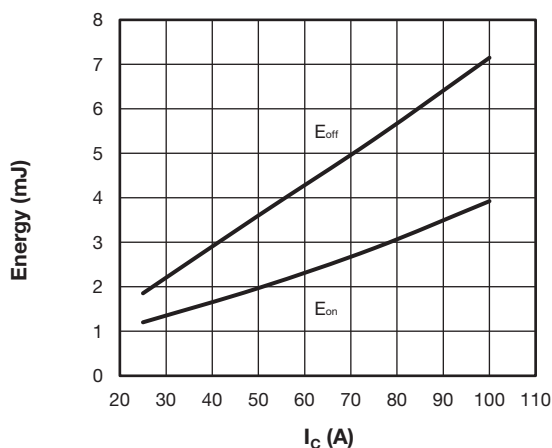
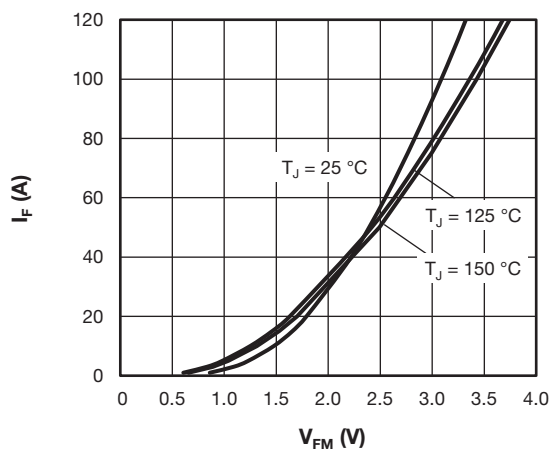

Fig. 10 - Typical IGBT Energy Loss vs.  $I_C$   
 $T_J = 125\text{ }^{\circ}\text{C}$ ,  $V_{CC} = 600\text{ V}$ ,  $R_g = 1.0\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$ 


Fig. 8 - Typical Diode Forward Characteristics

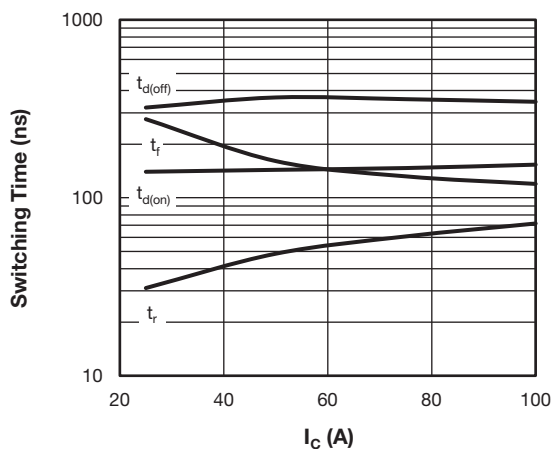
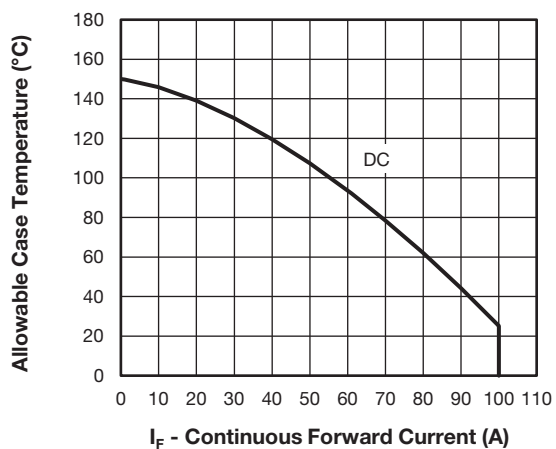
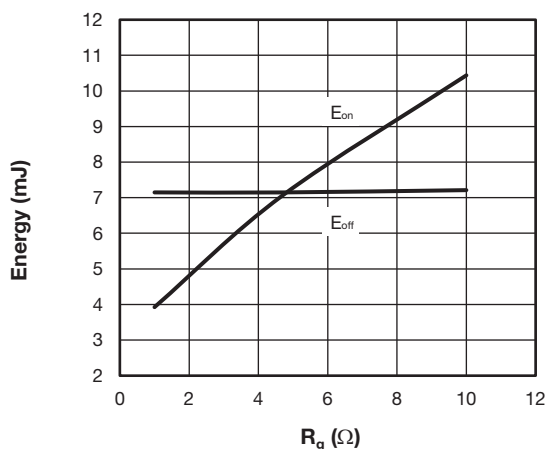

Fig. 11 - Typical IGBT Switching Time vs.  $I_C$   
 $T_J = 125\text{ }^{\circ}\text{C}$ ,  $V_{CC} = 600\text{ V}$ ,  $R_g = 1.0\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$ 


Fig. 9 - Maximum Diode Continuous Forward Current vs. Case Temperature


Fig. 12 - Typical IGBT Energy Loss vs.  $R_g$   
 $T_J = 125\text{ }^{\circ}\text{C}$ ,  $V_{CC} = 600\text{ V}$ ,  $I_C = 100\text{ A}$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

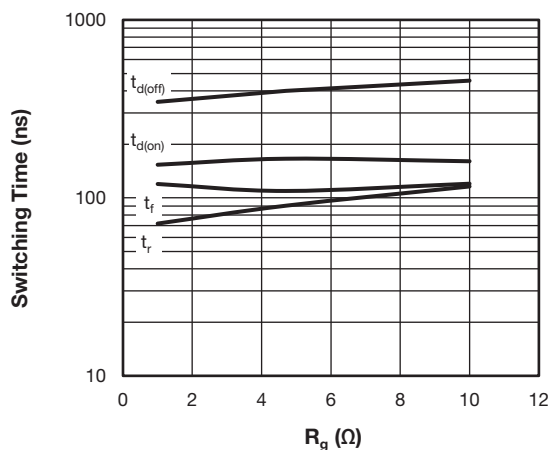


Fig. 13 - Typical IGBT Switching Time vs.  $R_g$   
 $T_J = 125^\circ\text{C}$ ,  $V_{CC} = 600\text{ V}$ ,  $I_C = 100\text{ A}$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

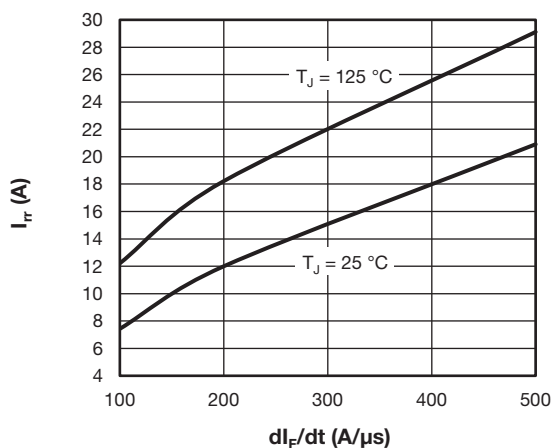


Fig. 15 - Typical Diode Reverse Recovery Current vs.  $di_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

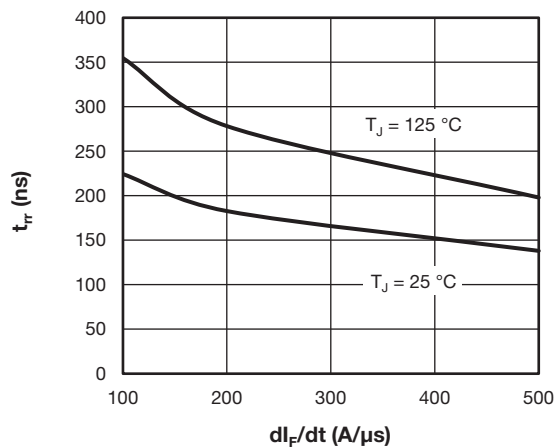


Fig. 14 - Typical Diode Reverse Recovery Time vs.  $di_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

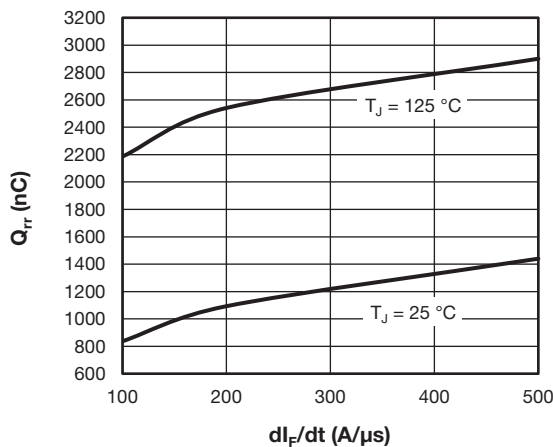


Fig. 16 - Typical Diode Reverse Recovery Charge vs.  $di_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

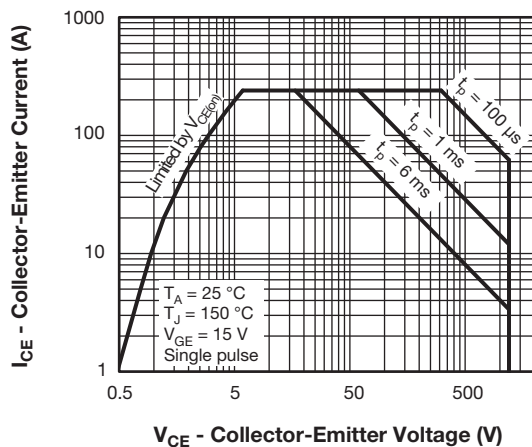


Fig. 17 - IGBT Safe Operating Area

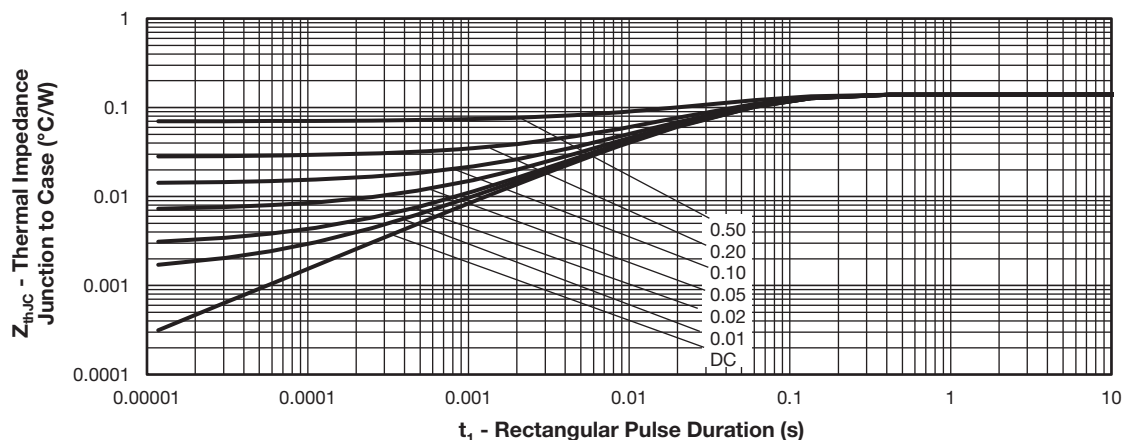


Fig. 18 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics - (IGBT)

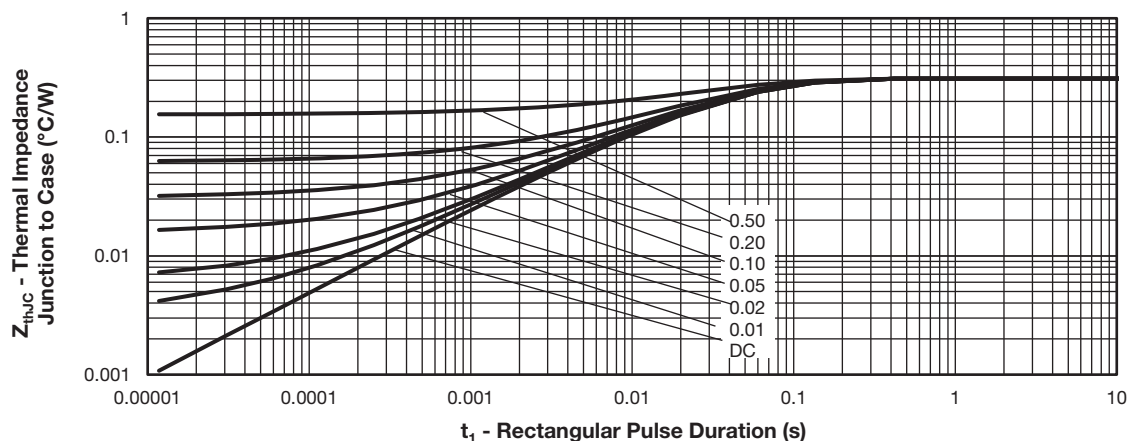


Fig. 19 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics - (Diode)

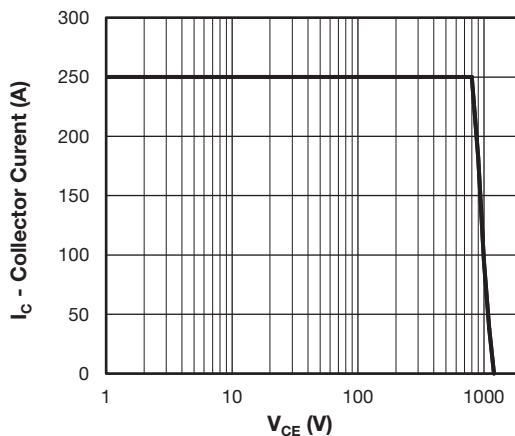
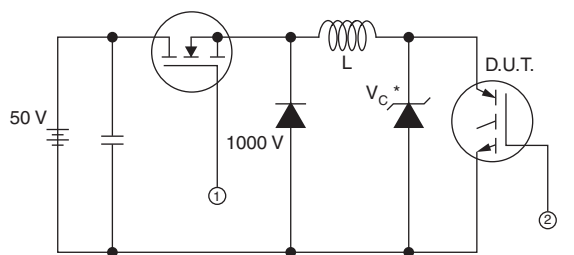


Fig. 20 - IGBT Reverse Bias SOA  
 $V_{GE} = 15\text{ V}$ ,  $T_J = 150^\circ\text{C}$



\* Driver same type as D.U.T.;  $V_C = 80\%$  of  $V_{ce(max)}$   
 \* Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain  $I_d$

Fig. 21 - Clamped Inductive Load Test Circuit

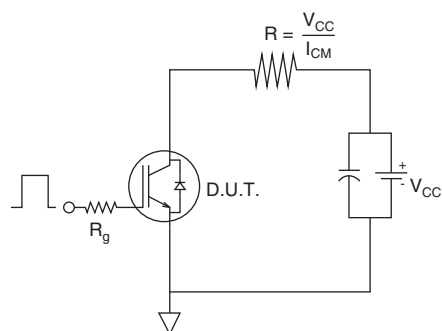


Fig. 22 - Pulsed Collector Current Test Circuit

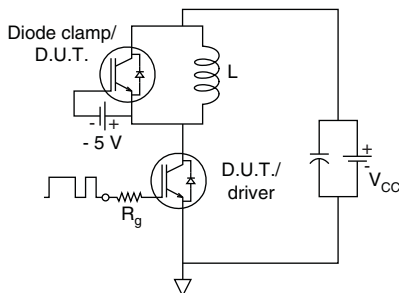


Fig. 23 - Switching Loss Test Circuit

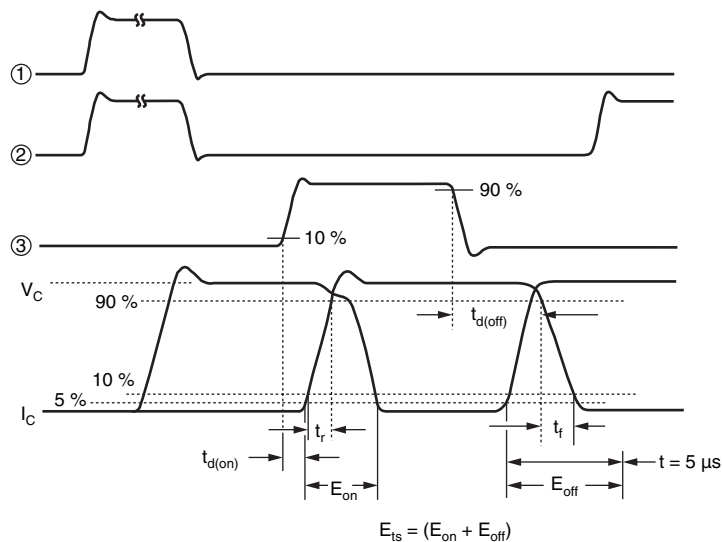


Fig. 24 - Switching Loss Waveforms Test Circuit



ORDERING INFORMATION TABLE

|             |     |   |   |     |   |   |     |    |
|-------------|-----|---|---|-----|---|---|-----|----|
| Device code | VS- | G | T | 100 | D | A | 120 | UF |
|             | 1   | 2 | 3 | 4   | 5 | 6 | 7   | 8  |

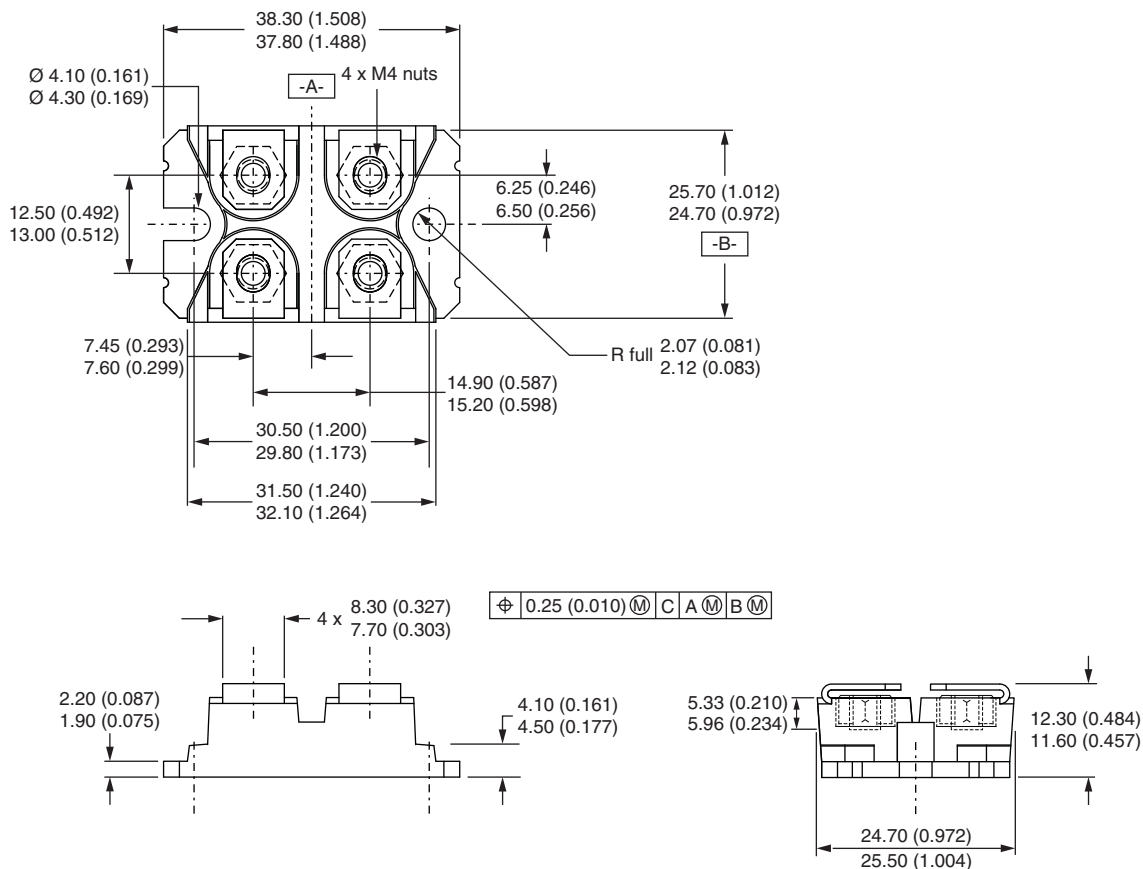
- |   |   |                                                                   |
|---|---|-------------------------------------------------------------------|
| 1 | - | Vishay Semiconductors product                                     |
| 2 | - | Insulated Gate Bipolar Transistor (IGBT)                          |
| 3 | - | Trench IGBT technology                                            |
| 4 | - | Current rating (100 = 100 A)                                      |
| 5 | - | Circuit configuration (D = single switch with antiparallel diode) |
| 6 | - | Package indicator (A = SOT-227)                                   |
| 7 | - | Voltage rating (120 = 1200 V)                                     |
| 8 | - | Speed/type (UF = Trench ultrafast IGBT)                           |

| CIRCUIT CONFIGURATION       |                            |                 |
|-----------------------------|----------------------------|-----------------|
| CIRCUIT                     | CIRCUIT CONFIGURATION CODE | CIRCUIT DRAWING |
| Single switch with AP diode | D                          | <br>            |

| LINKS TO RELATED DOCUMENTS |                                                                        |
|----------------------------|------------------------------------------------------------------------|
| Dimensions                 | <a href="http://www.vishay.com/doc?95423">www.vishay.com/doc?95423</a> |
| Packaging information      | <a href="http://www.vishay.com/doc?95425">www.vishay.com/doc?95425</a> |

## SOT-227 Generation 2

**DIMENSIONS** in millimeters (inches)



### Note

- Controlling dimension: millimeter



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